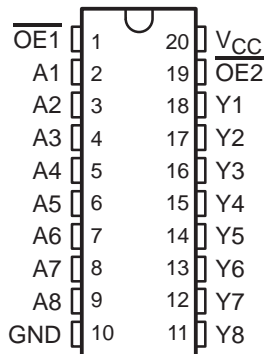


# SN54LV541A, SN74LV541A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

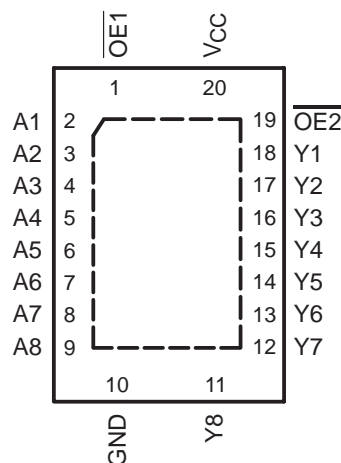
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- 2-V to 5.5-V  $V_{CC}$  Operation
- Max  $t_{pd}$  of 6 ns at 5 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  $<0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  $>2.3$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

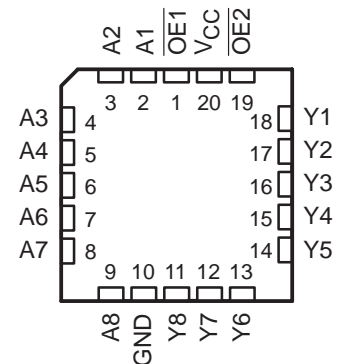
SN54LV541A . . . J OR W PACKAGE  
SN74LV541A . . . DB, DGV, DW, NS,  
OR PW PACKAGE  
(TOP VIEW)



SN74LV541A . . . RGY PACKAGE  
(TOP VIEW)



SN54LV541A . . . FK PACKAGE  
(TOP VIEW)



## description/ordering information

The 'LV541A devices are octal buffers/drivers designed for 2-V to 5.5-V  $V_{CC}$  operation.

## ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	QFN – RGY	Reel of 1000	SN74LV541ARGYR	LV541A
	SOIC – DW	Tube of 25	SN74LV541ADW	LV541A
		Reel of 2000	SN74LV541ADWR	
	SOP – NS	Reel of 2000	SN74LV541ANSR	74LV541A
	SSOP – DB	Reel of 2000	SN74LV541ADBR	LV541A
	TSSOP – PW	Tube of 70	SN74LV541APW	LV541A
		Reel of 2000	SN74LV541APWR	
Reel of 250		SN74LV541APWT		
TVSOP – DGV	Reel of 2000	SN74LV541ADGVR	LV541A	
–55°C to 125°C	CDIP – J	Tube of 20	SNJ54LV541AJ	SNJ54LV541AJ
	CFP – W	Tube of 85	SNJ54LV541AW	SNJ54LV541AW
	LCCC – FK	Tube of 55	SNJ54LV541AFK	SNJ54LV541AFK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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 **TEXAS  
INSTRUMENTS**

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# SN54LV541A, SN74LV541A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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## description/ordering information (continued)

These devices are ideal for driving bus lines or buffer memory address registers. They feature inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

The 3-state control gate is a two-input AND gate with active-low inputs so that if either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all corresponding outputs are in the high-impedance state. The outputs provide noninverted data when they are not in the high-impedance state.

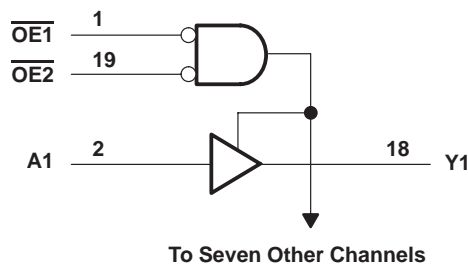
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

**FUNCTION TABLE**  
(each buffer/driver)

INPUTS			OUTPUT
$\overline{OE1}$	$\overline{OE2}$	A	Y
L	L	L	L
L	L	H	H
H	X	X	Z
X	H	X	Z

## logic diagram (positive logic)



**SN54LV541A, SN74LV541A**  
**OCTAL BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range, $V_{CC}$ .....	–0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	–0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) .....	–0.5 V to 7 V
Output voltage range applied in the high or low state, $V_O$ (see Notes 1 and 2) .....	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	–20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) .....	±50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	±35 mA
Continuous current through $V_{CC}$ or GND .....	±70 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DB package .....	70°C/W
(see Note 3): DGV package .....	92°C/W
(see Note 3): DW package .....	58°C/W
(see Note 3): NS package .....	60°C/W
(see Note 3): PW package .....	83°C/W
(see Note 4): RGY package .....	37°C/W
Storage temperature range, $T_{stg}$ .....	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  2. This value is limited to 5.5 V maximum.
  3. The package thermal impedance is calculated in accordance with JESD 51-7.
  4. The package thermal impedance is calculated in accordance with JESD 51-5.



# SN54LV541A, SN74LV541A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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## recommended operating conditions (see Note 5)

		SN54LV541A		SN74LV541A		UNIT	
		MIN	MAX	MIN	MAX		
$V_{CC}$	Supply voltage	2	5.5	2	5.5	V	
$V_{IH}$	High-level input voltage	$V_{CC} = 2\text{ V}$	1.5	1.5		V	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$			
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$			
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	$V_{CC} \times 0.7$	$V_{CC} \times 0.7$			
$V_{IL}$	Low-level input voltage	$V_{CC} = 2\text{ V}$	0.5		0.5	V	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	$V_{CC} \times 0.3$		$V_{CC} \times 0.3$		
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	$V_{CC} \times 0.3$		$V_{CC} \times 0.3$		
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	$V_{CC} \times 0.3$		$V_{CC} \times 0.3$		
$V_I$	Input voltage	0	5.5	0	5.5	V	
$V_O$	Output voltage	High or low state	0	$V_{CC}$	0	$V_{CC}$	V
		3-state	0	5.5	0	5.5	
$I_{OH}$	High-level output current	$V_{CC} = 2\text{ V}$	-50		-50	$\mu\text{A}$	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	-2		-2	mA	
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	-8		-8		
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	-16		-16		
$I_{OL}$	Low-level output current	$V_{CC} = 2\text{ V}$	50		50	$\mu\text{A}$	
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	2		2	mA	
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	8		8		
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	16		16		
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	200		200	ns/V	
		$V_{CC} = 3\text{ V to }3.6\text{ V}$	100		100		
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	20		20		
$T_A$	Operating free-air temperature	-55	125	-40	85	$^{\circ}\text{C}$	

NOTE 5: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$V_{CC}$	SN54LV541A			SN74LV541A			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{OH}$	$I_{OH} = -50\ \mu\text{A}$	2 V to 5.5 V	$V_{CC}-0.1$			$V_{CC}-0.1$			V
	$I_{OH} = -2\ \text{mA}$	2.3 V	2			2			
	$I_{OH} = -8\ \text{mA}$	3 V	2.48			2.48			
	$I_{OH} = -16\ \text{mA}$	4.5 V	3.8			3.8			
$V_{OL}$	$I_{OL} = 50\ \mu\text{A}$	2 V to 5.5 V	0.1			0.1			V
	$I_{OL} = 2\ \text{mA}$	2.3 V	0.4			0.4			
	$I_{OL} = 8\ \text{mA}$	3 V	0.44			0.44			
	$I_{OL} = 16\ \text{mA}$	4.5 V	0.55			0.55			
$I_I$	$V_I = 5.5\text{ V or GND}$	0 to 5.5 V	$\pm 1$			$\pm 1$			$\mu\text{A}$
$I_{OZ}$	$V_O = V_{CC}\text{ or GND}$	5.5 V	$\pm 5$			$\pm 5$			$\mu\text{A}$
$I_{CC}$	$V_I = V_{CC}\text{ or GND, } I_O = 0$	5.5 V	20			20			$\mu\text{A}$
$I_{off}$	$V_I\text{ or }V_O = 0\text{ to }5.5\text{ V}$	0	5			5			$\mu\text{A}$
$C_i$	$V_I = V_{CC}\text{ or GND}$	3.3 V	2			2			pF

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# SN54LV541A, SN74LV541A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV541A		SN74LV541A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_{pd}$	A	Y	$C_L = 15\text{ pF}$	6.7*	11.3*		1*	13.5*	1	13.5	ns
$t_{en}$	$\overline{OE}$	Y		8.5*	16.6*		1*	19.5*	1	19.5	
$t_{dis}$	$\overline{OE}$	Y		8.4*	13.1*		1*	15*	1	15	
$t_{pd}$	A	Y	$C_L = 50\text{ pF}$	8.7	15.9		1	18.5	1	18.5	ns
$t_{en}$	$\overline{OE}$	Y		10.5	20.7		1	24	1	24	
$t_{dis}$	$\overline{OE}$	Y		12.3	17.9		1	20	1	20	
$t_{sk(o)}$							2			2	

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV541A		SN74LV541A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_{pd}$	A	Y	$C_L = 15\text{ pF}$	4.8*	7*		1*	8.5*	1	8.5	ns
$t_{en}$	$\overline{OE}$	Y		6.1*	10.5*		1*	12.5*	1	12.5	
$t_{dis}$	$\overline{OE}$	Y		5.8*	11*		1*	12*	1	12	
$t_{pd}$	A	Y	$C_L = 50\text{ pF}$	6.1	10.5		1	12	1	12	ns
$t_{en}$	$\overline{OE}$	Y		7.4	14		1	16	1	16	
$t_{dis}$	$\overline{OE}$	Y		8.8	15.4		1	17.5	1	17.5	
$t_{sk(o)}$							1.5			1.5	

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV541A		SN74LV541A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_{pd}$	A	Y	$C_L = 15\text{ pF}$	3.5*	5*		1*	6*	1	6	ns
$t_{en}$	$\overline{OE}$	Y		4.3*	7.2*		1*	8.5*	1	8.5	
$t_{dis}$	$\overline{OE}$	Y		3.9*	7.5*		1*	8*	1	8	
$t_{pd}$	A	Y	$C_L = 50\text{ pF}$	4.3	7		1	8	1	8	ns
$t_{en}$	$\overline{OE}$	Y		5.3	9.2		1	10.5	1	10.5	
$t_{dis}$	$\overline{OE}$	Y		5.6	8.8		1	10	1	10	
$t_{sk(o)}$							1			1	

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**SN54LV541A, SN74LV541A**  
**OCTAL BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**noise characteristics,  $V_{CC} = 3.3\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (see Note 6)**

PARAMETER	SN74LV541A			UNIT
	MIN	TYP	MAX	
$V_{OL(P)}$ Quiet output, maximum dynamic $V_{OL}$		0.5	0.8	V
$V_{OL(V)}$ Quiet output, minimum dynamic $V_{OL}$		-0.4	-0.8	V
$V_{OH(V)}$ Quiet output, minimum dynamic $V_{OH}$		2.9		V
$V_{IH(D)}$ High-level dynamic input voltage	2.31			V
$V_{IL(D)}$ Low-level dynamic input voltage			0.99	V

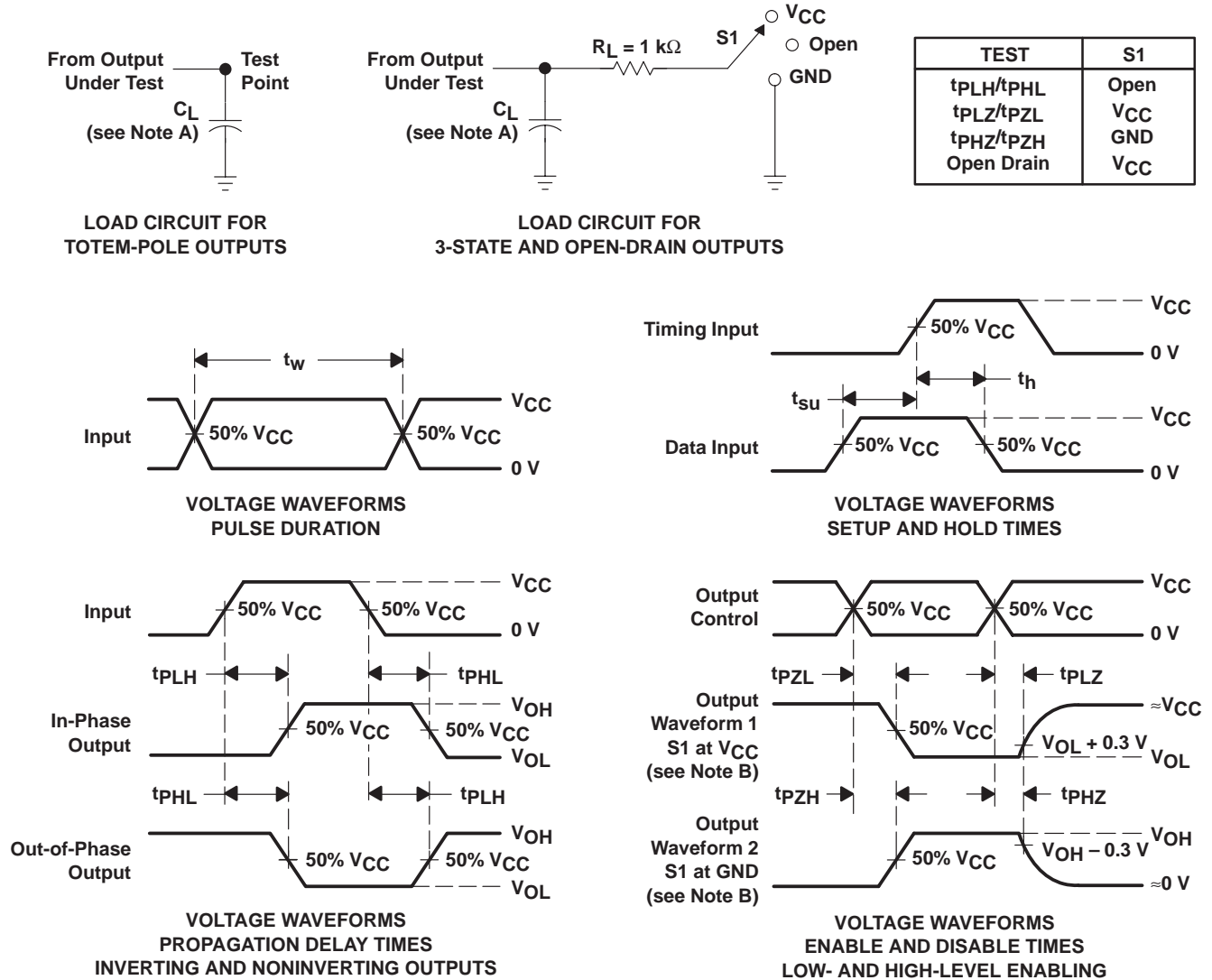
NOTE 6: Characteristics are for surface-mount packages only.

**operating characteristics,  $T_A = 25^\circ\text{C}$**

PARAMETER		TEST CONDITIONS	$V_{CC}$	TYP	UNIT
$C_{pd}$ Power dissipation capacitance	Outputs enabled	$C_L = 50\text{ pF}$ , $f = 10\text{ MHz}$	3.3 V	16.3	pF
			5 V	17.8	



PARAMETER MEASUREMENT INFORMATION



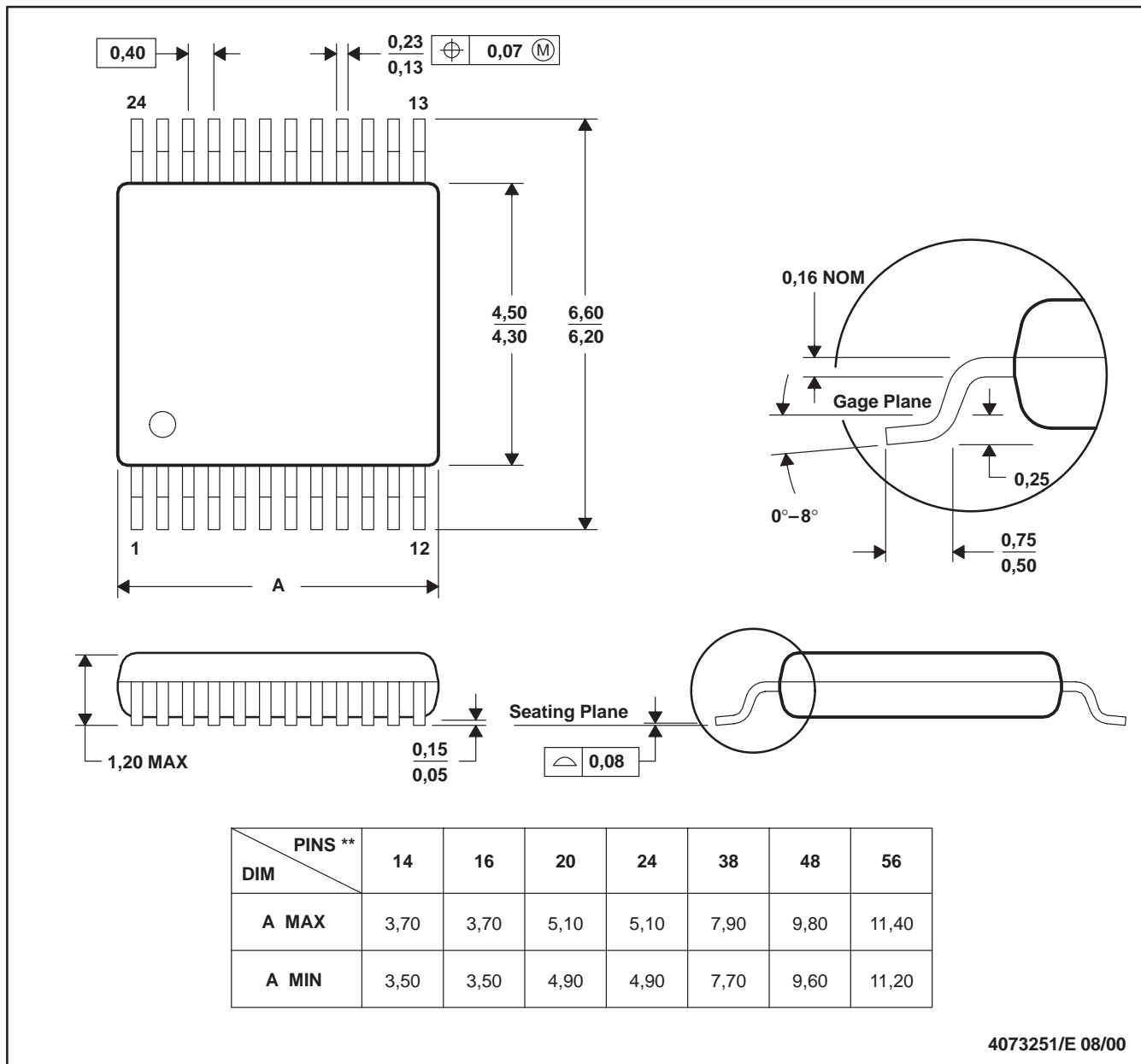
- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
  - D. The outputs are measured one at a time with one input transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

DGV (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN

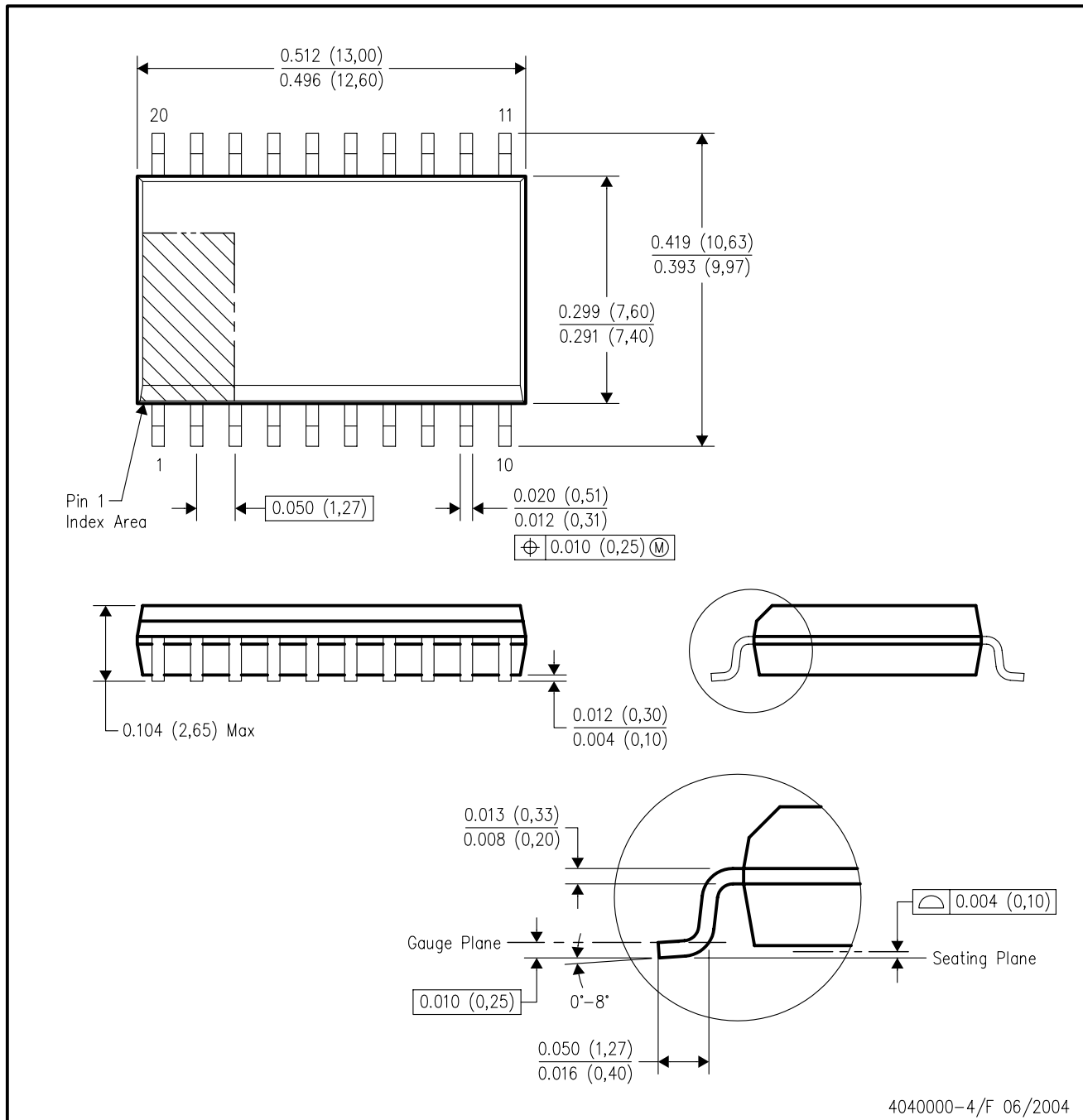


4073251/E 08/00

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE

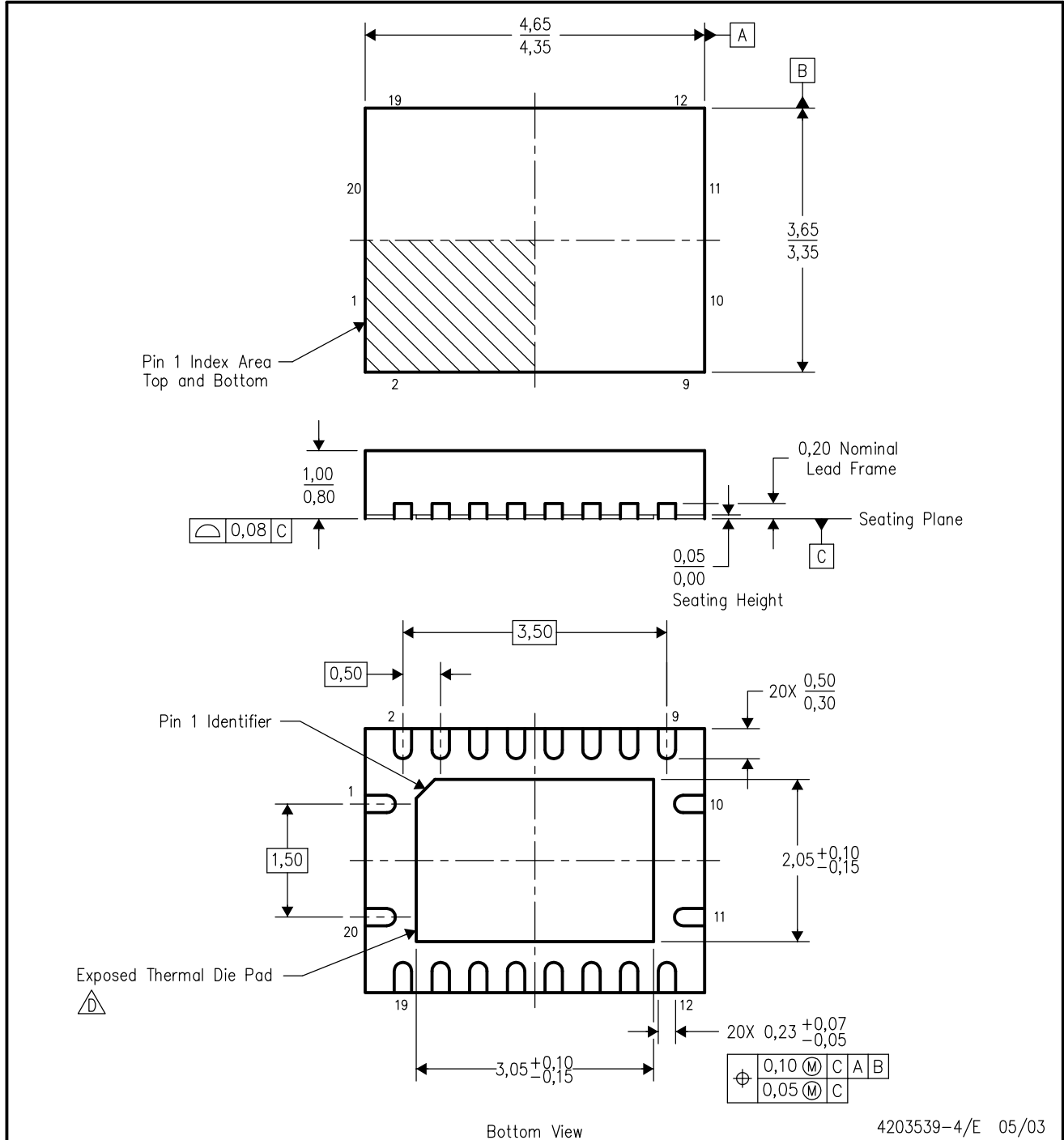


4040000-4/F 06/2004

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AC.

RGY (R-PQFP-N20)

PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. QFN (Quad Flatpack No-Lead) package configuration.
  - The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
  - E. Package complies to JEDEC MO-241 variation BC.

## MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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